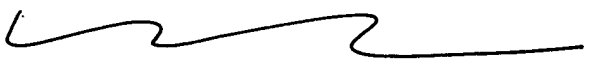


JPW

AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. SEC.736D	
Applicant(s): Choung_Hyep et al.					
Application No. 10/822,751	Filing Date April 13, 2004	Examiner Terrell L. McKinnon	Customer No. 20987	Group Art Unit 3743	Confirmation No. 2823
Invention: APPARATUS FOR AND METHOD OF HEAT-TREATING WAFER					
COMMISSIONER FOR PATENTS:					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	7 -	20 =	0	x \$50.00	\$0.00
INDEP. CLAIMS	1 -	3 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<div style="display: flex; flex-direction: row;"><div style="flex: 1;"><p><input checked="" type="checkbox"/> No additional fee is required for amendment.</p><p><input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____</p><p><input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed.</p><p><input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-0238</p><p style="margin-left: 20px;"><input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16.</p><p style="margin-left: 20px;"><input checked="" type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</p><p><input type="checkbox"/> Payment by credit card. Form PTO-2038.</p><p>WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.</p><div style="margin-top: 20px;"> _____ Signature</div></div><div style="flex: 1; padding-left: 20px;"><p>Dated: March 15, 2005</p></div></div>					
<p>LINUS Y. PARK Reg. No. 45,261 Volentine Francos & Whitt, P.L.L.C. One Freedom Square 11951 Freedom Drive, Suite 1260 Reston, VA 20191 Tel. No. (571) 283-0720</p>			<p>I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on</p> <p>_____ (Date)</p> <p>_____ Signature of Person Mailing Correspondence</p> <p>_____ Typed or Printed Name of Person Mailing Correspondence</p>		
CC:					



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of :

Choung-Hyep Kim et al. : Group Art Unit: 3743

Application No.: 10/822,751 : Examiner: Terrell L. McKinnon

Filed: April 13, 2004 :

APPARATUS FOR AND METHOD OF HEAT-TREATING WAFER

**AMENDMENT AND REQUEST FOR
RECONSIDERATION**

U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the Office Action dated January 26, 2005, the Applicants submit the following claims amendment, and remarks and arguments regarding the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.